

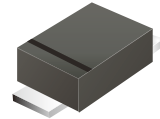
## SS54F-HF Thru. SS520F-HF

Reverse Voltage: 40 to 200 Volts

Forward Current: 5.0 Amp

RoHS Device

Halogen Free

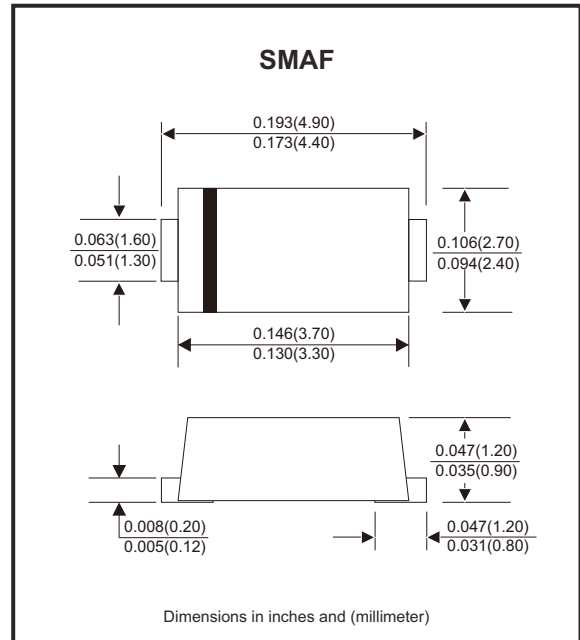


### Features

- Metal silicon junction, majority carrier conduction.
- For surface mounted applications.
- Low power loss, high efficiency.
- High forward surge current capability.
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications.

### Mechanical data

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, method 2026.



### Circuit Diagram



### Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.  
Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20%

Parameter	Symbols	SS54F-HF	SS56F-HF	SS510F-HF	SS515F-HF	SS520F-HF	Units
Maximum repetitive peak reverse voltage	$V_{RRM}$	40	60	100	150	200	V
Maximum RMS voltage	$V_{RMS}$	28	42	70	105	140	V
Maximum DC blocking voltage	$V_{DC}$	40	60	100	150	200	V
Maximum average forward rectified current	$I_{F(AV)}$	5					A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	$I_{FSM}$	120					A
Max instantaneous forward voltage at 5A	$V_F$	0.55	0.70	0.85			V
Maximum DC reverse current $T_j = 25^\circ\text{C}$ at rated DC reverse voltage $T_j = 100^\circ\text{C}$	$I_R$	1.0			50		mA
Typical junction capacitance (Note 1)	$C_j$	500	300				pF
Typical thermal resistance (Note 2)	$R_{\theta JA}$	60					$^\circ\text{C/W}$
Operating junction temperature range	$T_j$	-55 ~ +150					$^\circ\text{C}$
Storage temperature range	$T_{stg}$	-55 ~ +150					$^\circ\text{C}$

Notes: 1. Measured at 1 MHz and applied reverse voltage of 4 V D.C  
2. P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Company reserves the right to improve product design, functions and reliability without notice.

REV:A

## Rating and Characteristic Curves (SS54F-HF Thru. SS520F-HF)

Fig.1 - Forward Current Derating Curve

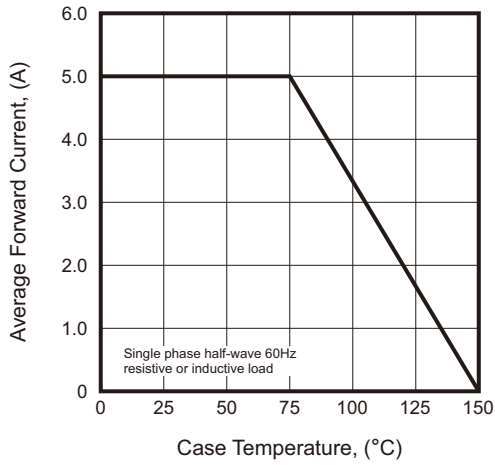


Fig.2 - Typical Reverse Characteristics

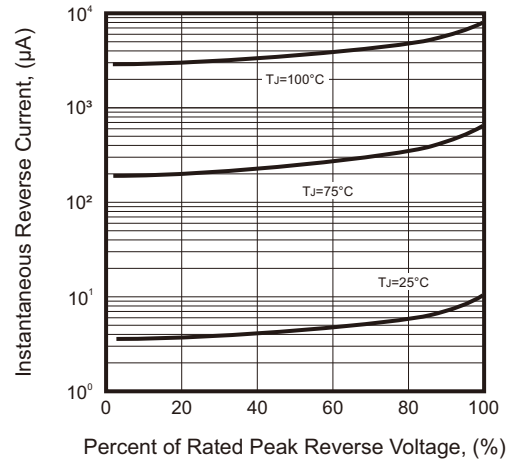


Fig.3 - Typical Forward Characteristic

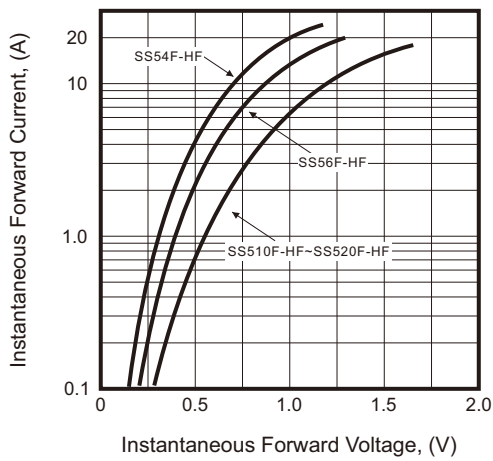


Fig.4 - Typical Junction Capacitance

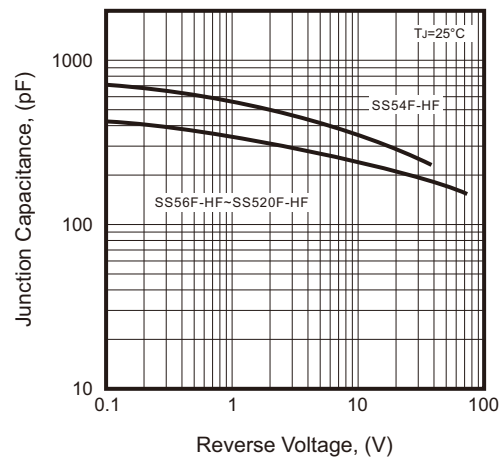


Fig.5 - Maximum Non-Repetitive Peak Forward Surge Current

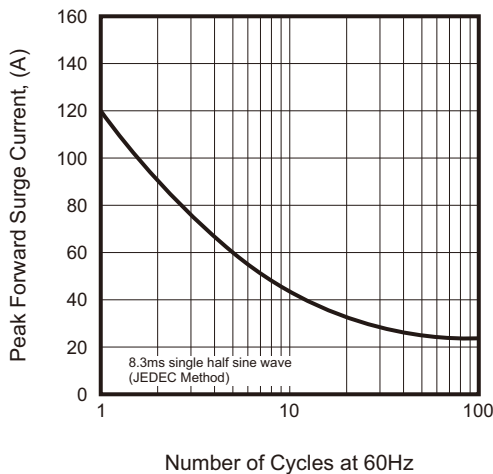
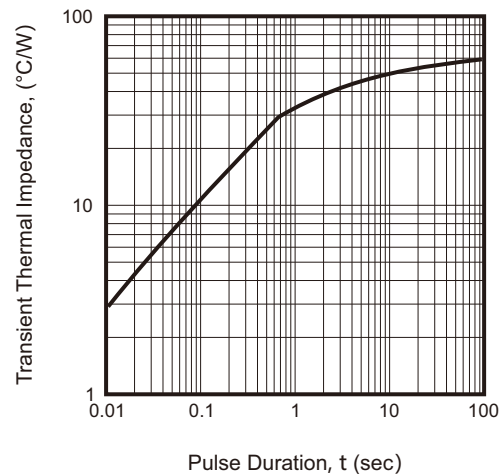
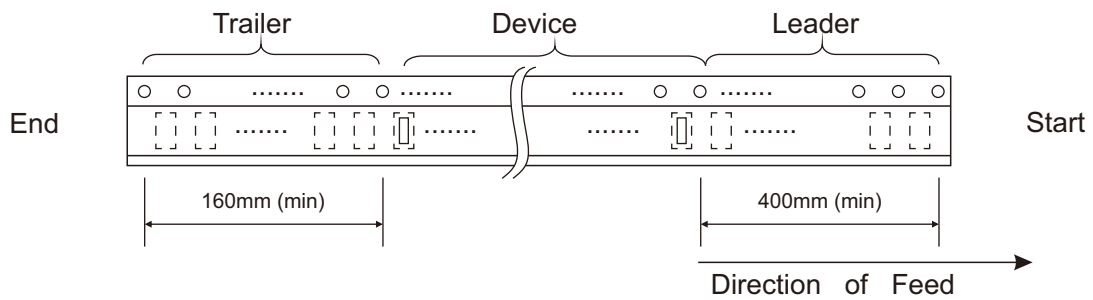
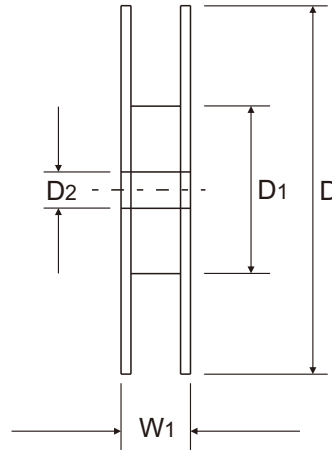
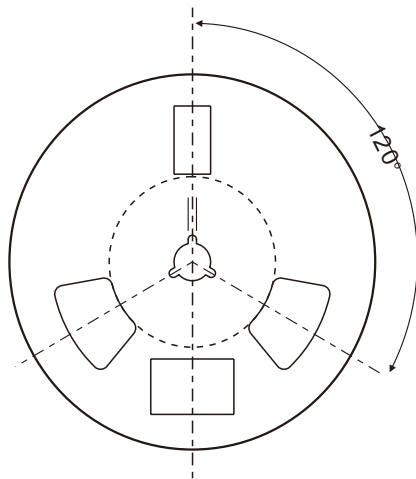
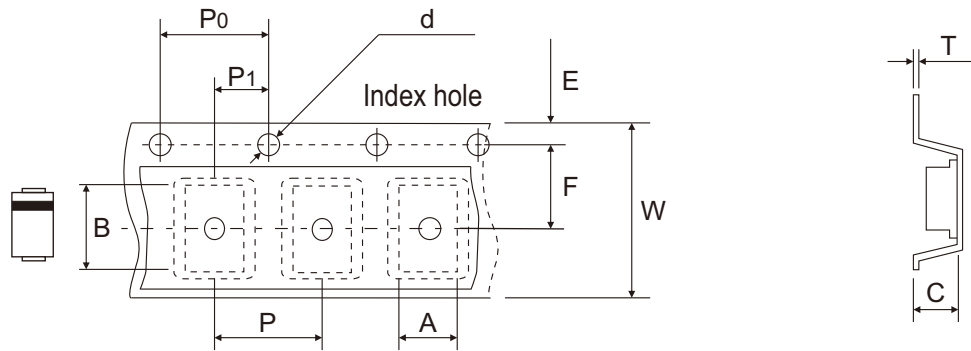


Fig.6 - Typical Transient Thermal Impedance



Company reserves the right to improve product design, functions and reliability without notice.

## Reel Taping Specification



SMAF	SYMBOL	A	B	C	d	D	D1	D2
	(mm)	2.93 ± 0.10	5.33 ± 0.10	1.33 ± 0.10	1.55 ± 0.05	330 ± 2.00	75.00 ± 1.00	13.00 ± 0.20
	(inch)	0.115 ± 0.004	0.210 ± 0.004	0.052 ± 0.004	0.061 ± 0.002	12.992 ± 0.079	2.953 ± 0.039	0.512 ± 0.008

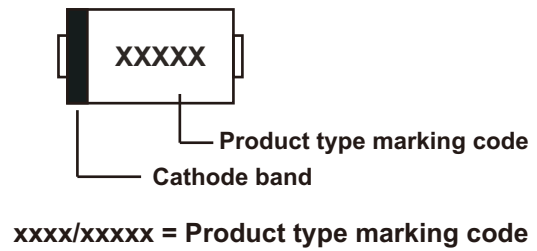
SMAF	SYMBOL	E	F	P	P0	P1	T	W	W1
	(mm)	1.73 ± 0.10	5.50 ± 0.10	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10	0.20 ± 0.03	12.00 ± 0.30	14.70 + 2.00 - 1.00
	(inch)	0.068 ± 0.004	0.217 ± 0.004	0.157 ± 0.004	0.157 ± 0.004	0.079 ± 0.004	0.008 ± 0.001	0.472 ± 0.012	0.579 + 0.079 - 0.039

Company reserves the right to improve product design, functions and reliability without notice.

REV:A

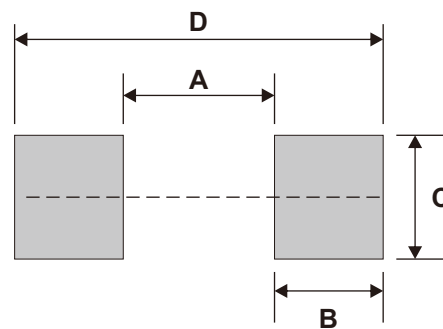
## Marking Code

Part Number	Marking Code
SS54F-HF	SS54
SS56F-HF	SS56
SS510F-HF	SS510
SS515F-HF	SS515
SS520F-HF	SS520



## Suggested PAD Layout

SIZE	SMAF	
	(mm)	(inch)
A	2.20	0.087
B	1.60	0.063
C	1.80	0.071
D	5.40	0.213



Note: 1. The pad layout is for reference purpose only.

## Standard Packaging

Case Type	REEL PACK	
	REEL ( pcs )	Reel Size (inch)
SMAF	10,000	13